



**BAS16TWQ** 

#### SURFACE MOUNT FAST SWITCHING DIODE ARRAY

#### **Features**

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Mechanical Data**

Case: SOT363

- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)

**SOT363** 







Top View Internal Schematic

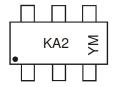
#### Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
BAS16TWQ-13R-F	Automotive	SOT363	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. -13R is part rotated in the pocket tape by +180°. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



KA2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015)

M = Month (ex: 9 = September)

Date Code Key

Year	2015	20	016	2017	2018	20	)19	2020	2021	20	22	2023
Code	С		D	Е	F	(	G	Н	I	,	J	K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		$V_{RM}$	100	V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	٧	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V	
Forward Continuous Current	(Note 6)	I <sub>FM</sub>	300	mA	
Average Rectified Output Current	(Note 6)	Io	150	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	2.0 0.5	A	

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 6)	$P_{D}$	200	mW
Thermal Resistance Junction to Ambient Air	(Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range		$T_J,T_STG$	-65 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

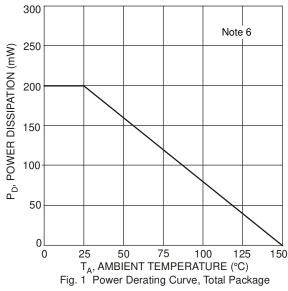
Characteristic			Min	Max	Unit	Test Condition
Reverse Breakdown Voltage	(Note 7)	$V_{(BR)R}$	75	_	V	$I_R = 1\mu A$
Forward Voltage		V <sub>F</sub>		0.715 0.855 1.0 1.25	٧	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Reverse Current	(Note 7)	I <sub>R</sub>	_	1.0 50 30 25		$V_R = 75V$ $V_R = 75V$ , $T_J = +150$ °C $V_R = 25V$ , $T_J = +150$ °C $V_R = 20V$
Total Capacitance		Ст	_	2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time		t <sub>RR</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

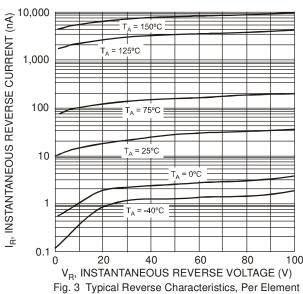
Notes:

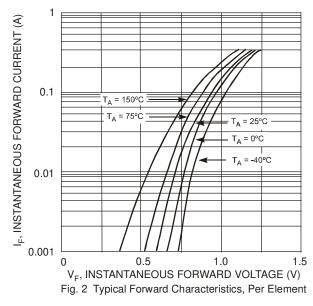
<sup>6.</sup> Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout can be found on our website at http://www.diodes.com/package-outlines.html.

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect.









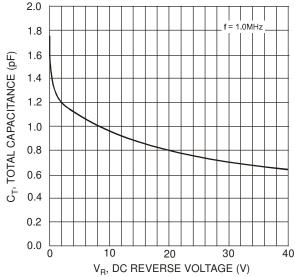
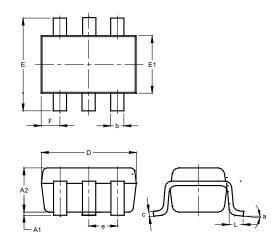


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

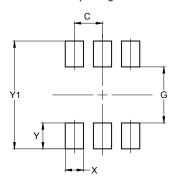


SO1363							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	1.00				
b	0.10	0.30	0.25				
C	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	e 0.650 BSC						
F	0.40	0.45	0.425				
٦	0.25	0.40	0.30				
а	0°	8°					
All Dimensions in mm							



### Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
X	0.420		
Y	0.600		
Y1	2.500		

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